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MM82C19 16-Line to 1-Line Multiplexer

General Description

The MM82C19 multiplex 16 digital lines to 1 output. A 4-bit address code determines the particular 1-of-16 inputs which is routed to the output. The data is inverted from input to output.

A strobe override places the output of MM82C19 in the high-impedance state.

All inputs are protected from damage due to static discharge by diode clamps to V_{CC} and GND.

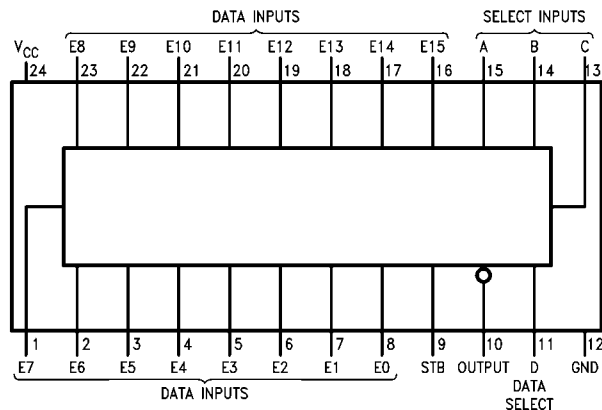
Features

- Wide supply voltage range: 3.0V to 15V
- Guaranteed noise margin: 1.0V
- High noise immunity: 0.45 V_{CC} (typ.)
- TTL compatibility: Drive 1 TTL Load

Ordering Code:

Order Number	Package Number	Package Description
MM82C19N	N24A	24-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-011, 0.600" Wide

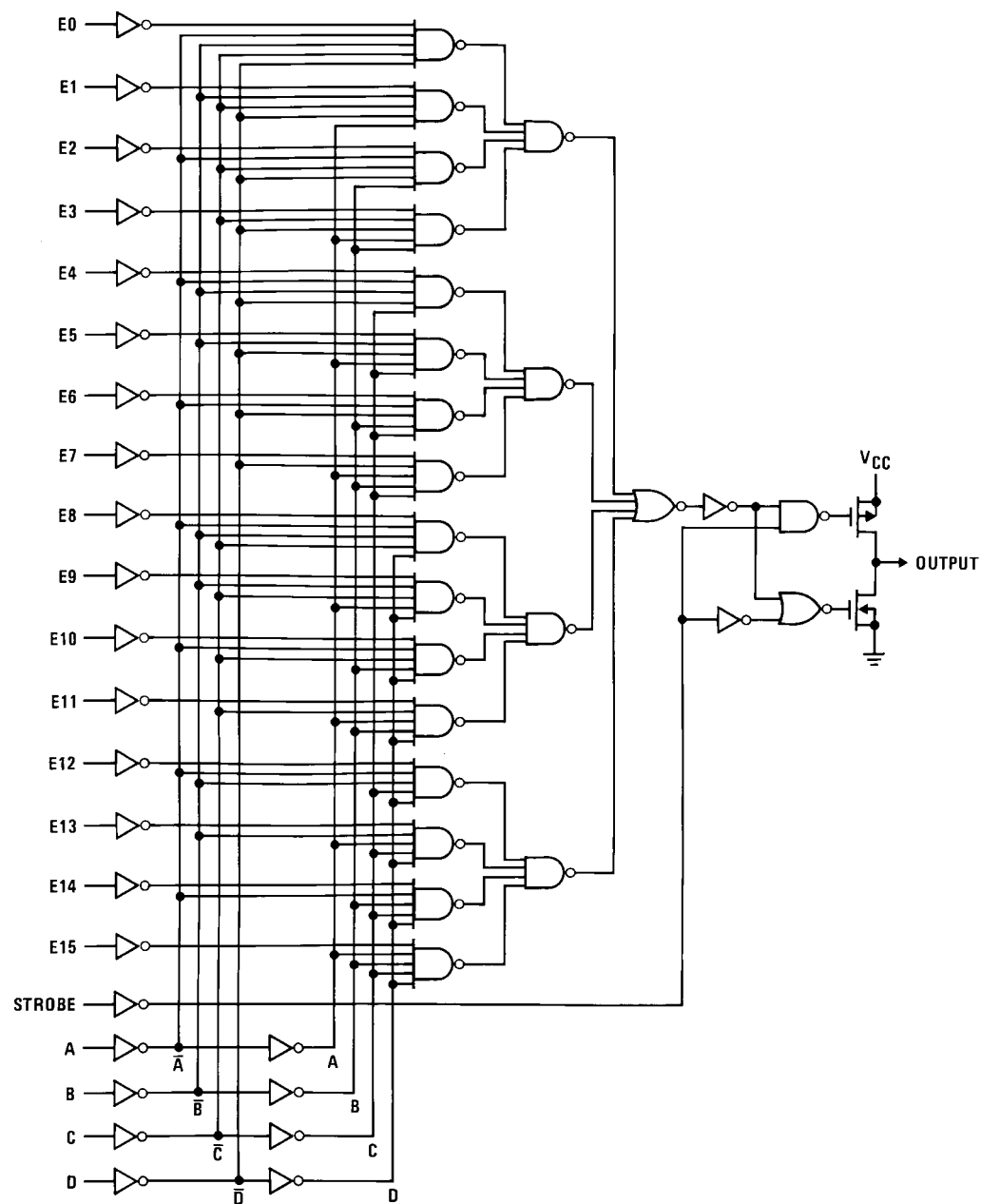
Connection Diagram



Truth Table

MM82C19

				Inputs																Output	
D	C	B	A	STROBE	E0	E1	E2	E3	E4	E5	E6	E7	E8	E9	E10	E11	E12	E13	E14	E15	W
X	X	X	X	1	X	X	X	X	X	X	X	X	X	X	X	X	X	X	X	X	High-Z
0	0	0	0	0	0	X	X	X	X	X	X	X	X	X	X	X	X	X	X	X	1
0	0	0	0	0	1	X	X	X	X	X	X	X	X	X	X	X	X	X	X	X	0
0	0	0	1	0	X	0	X	X	X	X	X	X	X	X	X	X	X	X	X	X	1
0	0	0	1	0	X	1	X	X	X	X	X	X	X	X	X	X	X	X	X	X	0
0	0	1	0	0	X	X	0	X	X	X	X	X	X	X	X	X	X	X	X	X	1
0	0	1	0	0	X	X	1	X	X	X	X	X	X	X	X	X	X	X	X	X	0
0	0	1	1	0	X	X	X	0	X	X	X	X	X	X	X	X	X	X	X	X	1
0	0	1	1	0	X	X	X	1	X	X	X	X	X	X	X	X	X	X	X	X	0
0	1	0	0	0	X	X	X	X	0	X	X	X	X	X	X	X	X	X	X	X	1
0	1	0	0	0	X	X	X	X	1	X	X	X	X	X	X	X	X	X	X	X	0
0	1	0	1	0	X	X	X	X	X	0	X	X	X	X	X	X	X	X	X	X	1
0	1	0	1	0	X	X	X	X	X	1	X	X	X	X	X	X	X	X	X	X	0
0	1	1	0	0	X	X	X	X	X	X	0	X	X	X	X	X	X	X	X	X	1
0	1	1	0	0	X	X	X	X	X	X	1	X	X	X	X	X	X	X	X	X	0
0	1	1	1	0	X	X	X	X	X	X	X	0	X	X	X	X	X	X	X	X	1
0	1	1	1	0	X	X	X	X	X	X	X	1	X	X	X	X	X	X	X	X	0
0	1	1	1	1	0	X	X	X	X	X	X	1	X	X	X	X	X	X	X	X	0
1	0	0	0	0	X	X	X	X	X	X	X	X	0	X	X	X	X	X	X	X	1
1	0	0	0	0	X	X	X	X	X	X	X	X	1	X	X	X	X	X	X	X	0
1	0	0	1	0	X	X	X	X	X	X	X	X	0	X	X	X	X	X	X	X	1
1	0	0	1	0	X	X	X	X	X	X	X	X	1	X	X	X	X	X	X	X	0
1	0	1	0	0	X	X	X	X	X	X	X	X	X	0	X	X	X	X	X	X	1
1	0	1	0	0	X	X	X	X	X	X	X	X	X	1	X	X	X	X	X	X	0
1	0	1	1	0	X	X	X	X	X	X	X	X	X	X	0	X	X	X	X	X	1
1	0	1	1	0	X	X	X	X	X	X	X	X	X	X	1	X	X	X	X	X	0
1	1	0	0	0	X	X	X	X	X	X	X	X	X	X	X	X	0	X	X	X	1
1	1	0	0	0	X	X	X	X	X	X	X	X	X	X	X	X	1	X	X	X	0
1	1	0	1	0	X	X	X	X	X	X	X	X	X	X	X	X	X	0	X	X	1
1	1	0	1	0	X	X	X	X	X	X	X	X	X	X	X	X	X	1	X	X	0
1	1	1	0	0	X	X	X	X	X	X	X	X	X	X	X	X	X	X	0	X	1
1	1	1	0	0	X	X	X	X	X	X	X	X	X	X	X	X	X	X	1	X	0
1	1	1	1	1	0	X	X	X	X	X	X	X	X	X	X	X	X	X	X	0	1
1	1	1	1	1	0	X	X	X	X	X	X	X	X	X	X	X	X	X	X	1	0



Absolute Maximum Ratings(Note 1)

Voltage at Any Pin	-0.3V to $V_{CC} + 0.3V$
Operating Temperature Range	-55°C to +125°C
Storage Temperature Range	-65°C to +150°C
Power Dissipation	
Dual-In-Line	700 mW
Small Outline	500 mW
Operating V_{CC} Range	3.0V to 15V
V_{CC}	18V
Lead Temperature (soldering, 10 seconds)	260°C

Note 1: "Absolute Maximum Ratings" are those values beyond which the safety of the device cannot be guaranteed. Except for "Operating Temperature Range" they are not meant to imply that the devices should be operated at these limits. The Electrical Characteristic table provides conditions for actual device operation.

DC Electrical Characteristics

Min/Max limits apply across temperature range unless otherwise noted.

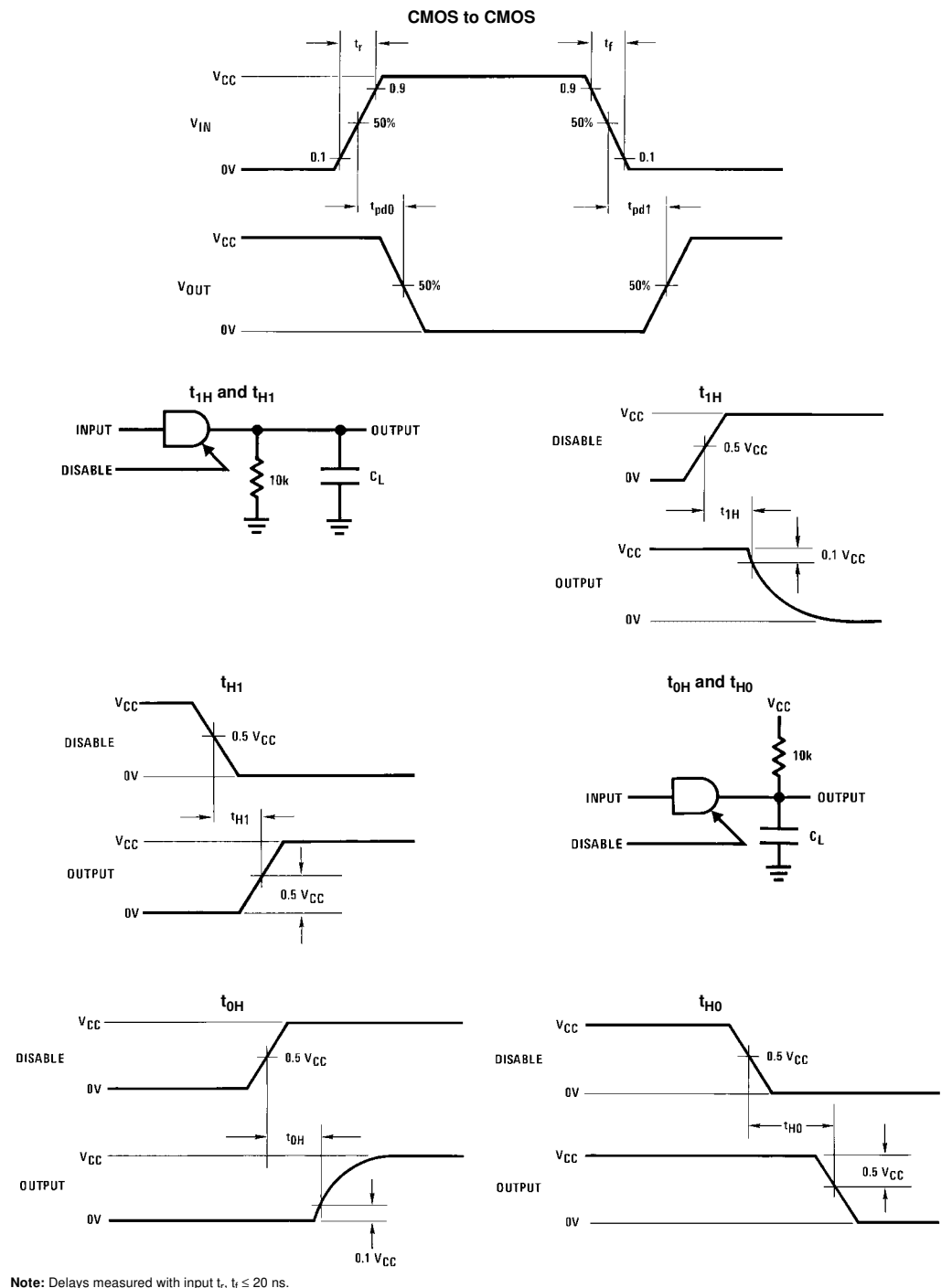
Symbol	Parameter	Conditions	Min	Typ	Max	Units
CMOS to CMOS						
$V_{IN(1)}$	Logical "1" Input Voltage	$V_{CC} = 5.0V$ $V_{CC} = 10V$	3.5 8.0			V
$V_{IN(0)}$	Logical "0" Input Voltage	$V_{CC} = 5.0V$ $V_{CC} = 10V$			1.5 2.0	V
$V_{OUT(1)}$	Logical "1" Output Voltage	$V_{CC} = 5.0V, I_O = -10 \mu A$ $V_{CC} = 10V, I_O = -10 \mu A$	4.5 9.0			V
$V_{OUT(0)}$	Logical "0" Output Voltage	$V_{CC} = 5.0V, I_O = +10 \mu A$ $V_{CC} = 10V, I_O = +10 \mu A$			0.5 1.0	V
$I_{IN(1)}$	Logical "1" Input Current	$V_{CC} = 15V, V_{IN} = 15V$		0.005	1.0	V
$I_{IN(0)}$	Logical "0" Input Current	$V_{CC} = 15V, V_{IN} = 0V$	-1.0	-0.005		μA
I_{OZ}	Output Current in High Impedance State MM82C19	$V_{CC} = 15V, V_O = 15V$ $V_{CC} = 15V, V_O = 0V$	-1.0	0.005 -0.005	1.0	μA
I_{CC}	Supply Current	$V_{CC} = 15V$		0.05	300	μA
CMOS/LPTTL Interface						
$V_{IN(1)}$	Logical "1" Input Voltage	74C, 82C, $V_{CC} = 4.75V$	$V_{CC} - 1.5$			V
$V_{IN(0)}$	Logical "0" Input Voltage	74C, 82C, $V_{CC} = 4.75V$			0.8	V
$V_{OUT(1)}$	Logical "1" Output Voltage	74C, 82C, $V_{CC} = 4.75V, I_O = -1.6 mA$	2.4			V
$V_{OUT(0)}$	Logical "0" Output Voltage	74C, 82C, $V_{CC} = 4.75V, I_O = 1.6 mA$			0.4	V
Output Drive (Short Circuit Current)						
I_{SOURCE}	Output Source Current (P-Channel)	$V_{CC} = 5.0V, V_{OUT} = 0V, T_A = 25^\circ C$	-4.35	-8		mA
I_{SOURCE}	Output Source Current (P-Channel)	$V_{CC} = 10V, V_{OUT} = 0V, T_A = 25^\circ C$	-20	-40		mA
I_{SINK}	Output Sink Current (N-Channel)	$V_{CC} = 5.0V, V_{OUT} = V_{CC}, T_A = 25^\circ C$	4.35	8		mA
I_{SINK}	Output Sink Current (N-Channel)	$V_{CC} = 10V, V_{OUT} = V_{CC}, T_A = 25^\circ C$	20	40		mA

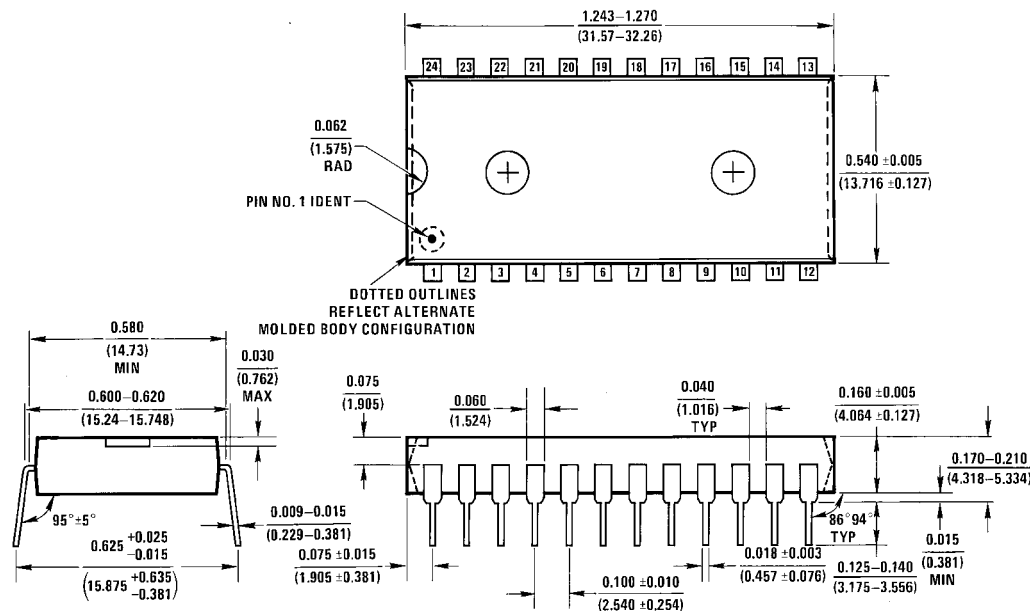
AC Electrical Characteristics (Note 2) $T_A = 25^\circ\text{C}$, $C_L = 50\text{ pF}$, unless otherwise noted

Symbol	Parameter	Conditions	Min	Typ	Max	Units
t_{pd0} , t_{pd1}	Propagation Delay Time to a Logical "0" or Logical "1" from Data Inputs to Output	$V_{CC} = 5.0\text{V}$ $V_{CC} = 10\text{V}$ $V_{CC} = 5.0\text{V}$, $C_L = 150\text{ pF}$ $V_{CC} = 10\text{V}$, $C_L = 150\text{ pF}$		250 110 290 120	600 300 650 330	ns
t_{pd0} , t_{pd1}	Propagation Delay Time to a Logical "0" or Logical "1" from Data Select Inputs to Output	$V_{CC} = 5.0\text{V}$ $V_{CC} = 10\text{V}$		290 120	650 330	ns
t_{pd0} , t_{pd1}	Propagation Delay Time to a Logical "0" or Logical "1" from Strobe to Output MM74C150	$V_{CC} = 5.0\text{V}$ $V_{CC} = 10\text{V}$		120 55	300 150	ns
t_{1H} , t_{0H}	Delay from Strobe to High Impedance State MM82C19	$V_{CC} = 5.0\text{V}$, $R_L = 10\text{k}$, $C_L = 5\text{ pF}$ $V_{CC} = 10\text{V}$, $R_L = 10\text{k}$, $C_L = 5\text{ pF}$		80 60	200 150	ns
t_{H1} , t_{H0}	Delay from Strobe to Logical "1" Level or to Logical "0" Level (from High Impedance State) MM82C19	$V_{CC} = 5.0\text{V}$, $R_L = 10\text{k}$, $C_L = 5\text{ pF}$ $V_{CC} = 10\text{V}$, $R_L = 10\text{k}$, $C_L = 5\text{ pF}$		80 30	250 120	ns
C_{IN}	Input Capacitance	Any Input (Note 3)		5.0		pF
C_{OUT}	Output Capacitance MM82C19	(Note 3)		11.0		pF
C_{PD}	Power Dissipation Capacitance	(Note 4)		100		pF

Note 2: AC Parameters are guaranteed by DC correlated testing.**Note 3:** Capacitance is guaranteed by periodic testing.**Note 4:** C_{PD} determines the no load AC power consumption of any CMOS device. For complete explanation, see Family Characteristics, application note AN-90.

Switching Time Waveforms



Physical Dimensions inches (millimeters) unless otherwise noted

N24A (REV E)

**24-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-011, 0.600" Wide
Package Number N24A**

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